

RF ESD Protection Diodes

ESD protection of RF antenna /

interfaces or ultra high speed data lines acc. to:

IEC61000-4-2 (ESD): ± 15 KV (air / contact)

IEC61000-4-4 (EPT): 40 A (5/50 ns)

IEC61000-4-5 (surge): 5 A (8/20 μs)

Very low line capacitance: 0.4 pF @ 1 GHz
 (0.2 pF per diode)



Very low clamping voltage

• Ultra small leadless package:1.2 x 0.8 x 0.39 mm³

• Pb-free (RoHS compliant) package

Applications in anti-parallel configuration

 For low RF signal levels without superimposed DC voltage: e.g. GPS, XM-Radio, Sirius, DVB, DMB, DAB, Remote Keyless Entry

Applications in rail-to-rail configuration

 For high RF signal levels or low RF signal levels with superimposed DC voltage: e.g. HDMI, S-ATA, Gbit Ethernet



ESD0P4RFL



Туре	Package	Configuration	Marking
ESD0P4RFL	TSLP-4-7	anti-parallel	E4





Maximum Ratings at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Value	Unit
ESD contact discharge ¹⁾	V _{ESD}	15	kV
Peak pulse current $(t_p = 8 / 20 \mu s)^2$	I _{pp}	5	А
Operating temperature range	Top	-55150	°C
Storage temperature	$T_{ m stg}$	-65150	

Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics -	•	•		•	•
Reverse working voltage ³⁾	V_{RWM}	-	-	50	V
Reverse current ³⁾	I _R	-	20	100	nA
V _R = 50 V					
Forward clamping voltage ²⁾	V _{FC}	-	6	9	V
$I_{PP} = 5 A$					
Diode capacitance ⁴⁾	C _T	-	0.4	-	pF
$V_{R} = 0 \text{ V}, f = 1 \text{ GHz}$					
Series inductance per diode	LS	_	0.4	-	nH

¹V_{ESD} according to IEC61000-4-2, only valid in anti-parallel or rail-to-rail connection.

Please refer to the application examples.

 $^{^2}I_{\mbox{\footnotesize pp}}$ according to IEC61000-4-5, only valid in anti-parallel or rail-to-rail connection.

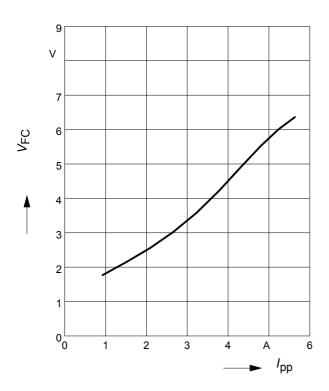
Please refer to the application examples.

 $^{^3}$ Only valid in rail-to-rail configuration with $V_{CC} \le V_{RWM}$

⁴Total capacitance line to ground (2 diodes in parallel)

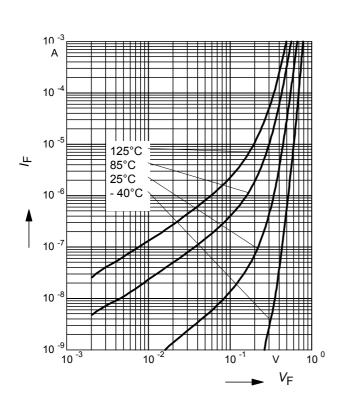


Forward clamping voltage V_{FC} = $f(I_{PP})$ t_p = 8 / 20 µs



Forward current $I_F = f(V_F)$

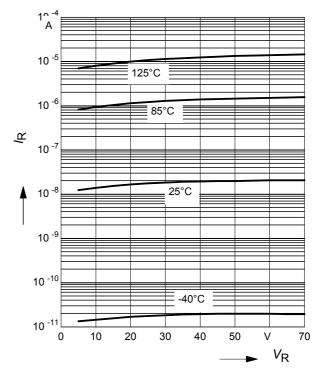
leakage in anti-parallel configuration



Reverse current $I_R = f(V_R)$

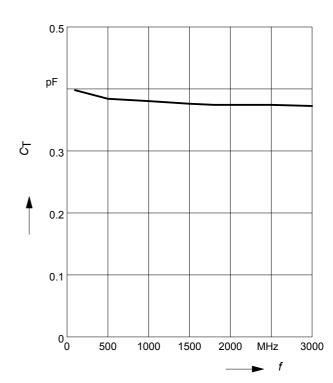
 T_A = Parameter

leakage in rail-to-rail configuration



Line capacitance $C_T = f$ (f)

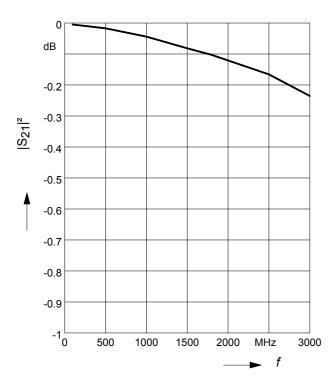
$$V_R = 0 V$$





Insertion loss $I_{L} = -|S_{21}|^2 = f(f)$

$$V_{R} = 0 \text{ V}, Z = 50 \Omega$$

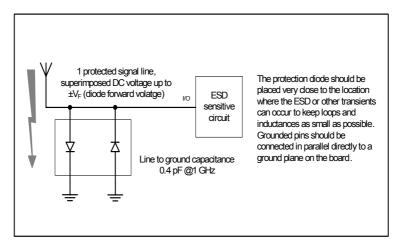


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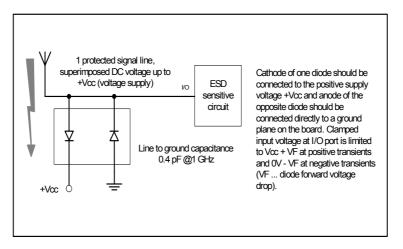
1. Application example ESD0P4RFL

1 RF signal channel, anti-parallel configuration



2. Application example ESD0P4RFL

1 RF signal channel, rail-to-rail configuration

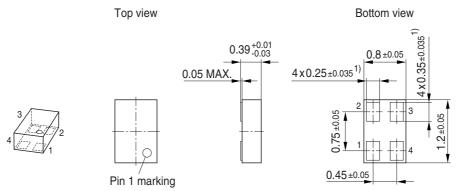


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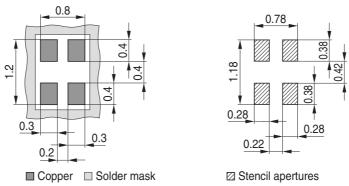
Package Outline



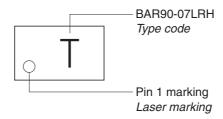
1) Dimension applies to plated terminal

Foot Print

For board assembly information please refer to Infineon website "Packages"

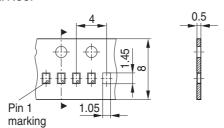


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel



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